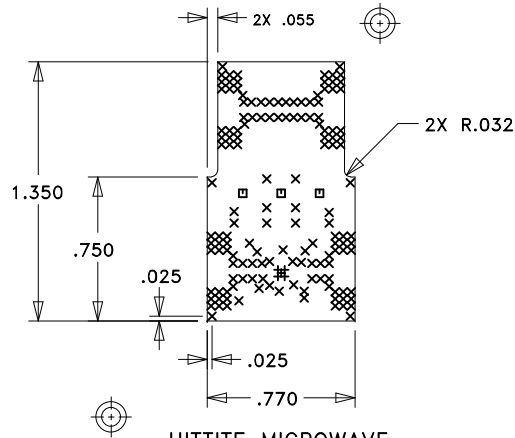


REVISION			
LTR	DESCRIPTION	DATE	APPROVED
1	ENGINEERING RELEASE	01/17/11	V. LY



HITTITE MICROWAVE
PCB #600-00077-00-1
DRILL DRAWING

SIZE	QTY	SYM	PLATED	TOL
10	5	+	YES	+/-3
14	145	X	YES	+/-3
43	3	□	YES	+/-3

NOTES:

UNLESS OTHERWISE SPECIFIED:

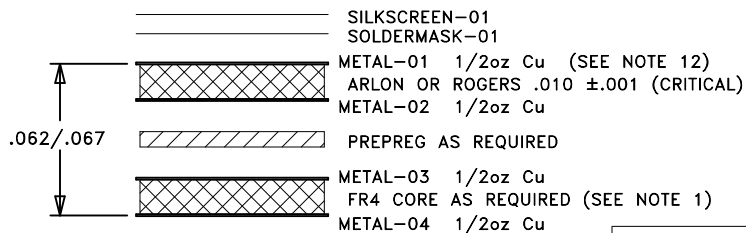
1. MATERIAL: MULTILAYER. OVERALL STACKUP AS SHOWN. TYPE ARLON 25FR OR ROGERS 4350, HALF OUNCE COPPER BOTH SIDES. FR4 TO BE USED AS FILLER TO MEET CRITICAL OVERALL THICKNESS.
2. FINISH: GOLD PLATE PER ASTM B-488, TYPE III, CODE A, 8 TO 40 MICROINCHES, OVER NICKEL PER QQ-N-290, 100 MICROINCHES MINIMUM.
3. PLATED THRU HOLES: .001 MINIMUM WALL THICKNESS.
4. HOLE SIZES AND POSITIONS PER ARTWORK AND/OR DRILL FILE.
5. ALL HOLES TO BE LOCATED WITHIN ± 0.003 OF THE CENTER OF THE PAD OR OTHER TRUE POSITION.
6. FRONT TO BACK REGISTRATION ± 0.003 MAX.
7. BOARD WARPAGE: < 0.010 PER LINEAR INCH.
8. SILKSCREEN TOP SIDE ONLY WITH WHITE EPOXY INK.
9. SOLDERMASK: LPI SOLDERMASK TOP SIDE. COLOR: GREEN REGISTRATION: ± 0.004 MAX.
10. "SIZE" IN DRILL LEGEND IS IN MILS AND REFERS TO FINISHED HOLE SIZE.
11. MANUFACTURE PER IPC-6012 CLASS 2.

SPECIAL REQUIREMENTS:

12. CRITICAL LINE WIDTH = $.016 \pm 0.001$ ON METAL-01. ADJUST PROCESS TO ACHIEVE WIDTH.

VENDOR NOTES:

13. VENDOR MAY ADD E-TEST STAMP TO PCB. VENDOR SHALL NOT ADD NAME, LOGO, DATE CODE, UL LISTING OR ANY OTHER MARKING TO ANY VISIBLE LAYER.
14. BOARDS MUST PASS VISUAL INSPECTION PER IPC-A-600 CLASS 2.



LAYER STACKUP

UNLESS OTHERWISE SPECIFIED:	
DIMENSIONS ARE IN INCHES [mm]	
DRAWING PRACTICES PER ASME Y14.100	
INTERPRET DIMENSIONS & TOLERANCES PER ASME Y14.5-2009	
TOLERANCES:	
.XX	$\pm .01$
.XXX	$\pm .005$
.XXXX	$\pm .0020$
ANGLES	$\pm .5$ DEG.

XXXXXX	USED ON
NEXT ASSY	

PROPRIETARY TO HITTITE MICROWAVE CORPORATION



HITTITE MICROWAVE CORPORATION
20 Alpha Road
Chelmsford, MA 01824

TITLE PCB, EVAL 1430MHZ TUNE HMC618LP3E			
SIZE A	CODE ID NO. 1CN88	DWG NO. 600-00077-00	REV 1
SCALE: 1:1		WT:	SHEET: 1 OF 1